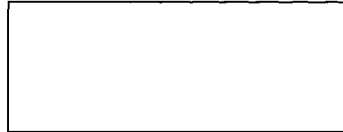


# International Rectifier IRFK6H250, IRFK6J250

## Isolated Base Power HEX-pak™ Assembly - Parallel Chip Configuration

- High Current Capability.
- UL recognised E78996.
- Electrically Isolated Base Plate.
- Easy Assembly into Equipment.



### Description

The HEX-pak™ utilises the well-proven HEXFET™ die, combining low on-state resistance with high transconductance. These superior technology die are assembled by state of the art techniques into the TO-240 package, featuring 2.5kV rms isolation and solid M5 screw connections. The small footprint means the package is highly suited to power applications where space is a premium. Available in two versions, IRFK.H... for fast switching and IRFK.J... for oscillation sensitive applications.

$$V_{DS} = 200V$$

$$R_{DS(on)} = 15m\Omega$$

$$I_D = 140A$$

### Absolute Maximum Rating

Parameter	Max.	Units
$I_D @ T_C=25^\circ C$	140	A
$I_D @ T_C=100^\circ C$	90	A
$I_{DM}$	560	A ①
$P_D @ T_C=25^\circ C$	625	W
$V_{GS}$	20	V
$V_{INS}$	2.5	kV
$T_J$	-40 to 150	°C
$T_{STG}$	-40 to 150	°C

### Thermal and Mechanical Specifications

Parameter	Min.	Typ.	Max.	Units
$R_{\theta JC}$	-	-	0.20	K/W ②
$R_{\theta CS}$	-	0.1	-	K/W
T	Mounting Torque +10%	-	-	③
	HEXpak to Heatsink	-	5	Nm
	Busbar to HEXpak	-	3	Nm
wt	Approximate Weight	-	140	g
		-	5	oz
		-	-	-

#### Notes:

- ① - Repetitive Rating: Pulse width limited by maximum junction temperature see figure 8.
- ② - Per Module.
- ③ - A mounting compound is recommended and the torque should be rechecked after a period of three hours to allow for the spread of the compound.

# IRFK6H250, IRFK6J250



## Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (Unless otherwise specified)

Parameter	Parameter	Min.	Typ.	Max.	Units	Test Conditions	
$B_{VDSS}$	Drain-to-Source Breakdown voltage	200	-	-	V	$V_{GS}=0V, I_D=1.0mA$	
$R_{DS(on)}$	Static Drain-to-Source On-State Resistance	-	12	15	m $\Omega$	$V_{GS}=10V, I_D=90A$	
$I_{D(on)}$	On-State Drain Current	140	-	-	A	$V_{DS} > I_{D(on)} \times R_{DS(on)}$ max, $V_{GS}=10V$	
$V_{GS(th)}$	Gate Threshold Voltage	2.0	-	4.0	V	$V_{DS}=V_{GS}, I_D=1.5mA$	
$g_{fs}$	Forward Transconductance ④	66	100	-	S	$V_{DS} > 50V, I_D=90A$	
$I_{DSS}$	Zero Gate Voltage Drain Current	-	-	1.5	mA	$V_{DS}=V_{DS}max, V_{GS}=0V$	
		-	-	6.0	mA	$V_{GS}=10V, T_C=125^\circ\text{C}, V_{DS}=V_{DS}max \times 0.8$	
$I_{GSS}$	Gate-to-Source Leakage Forward	-	-	600	nA	$V_{GS}=20V$	
$I_{GSS}$	Gate-to-Source Leakage Reverse	-	-	-600	nA	$V_{GS}=-20V$	
$Q_g$	Total Gate Charge	-	500	610	nC	$I_D=140A, V_{GS}=10V,$	
$Q_{gs}$	Gate-to-Source Charge	-	75	120	nC	$V_{DS}=V_{DS}max \times 0.8$	
$Q_{gd}$	Gate-to-Drain ("Miller") Charge	-	260	400	nC		
$t_{d(on)}$	Turn-on Delay Time	IRFK6H250	-	65	-	ns	$V_{DD}=95V, I_D=90A,$ $V_{GS}=10V,$
		IRFK6J250	-	75	-	ns	
$t_r$	Rise Time	IRFK6H250	-	200	-	ns	$R_{SOURCE}=3.3\Omega$
		IRFK6J250	-	250	-	ns	
$t_{d(off)}$	Turn-off Delay Time	IRFK6H250	-	300	-	ns	$R_{SOURCE}=3.3\Omega$
		IRFK6J250	-	400	-	ns	
$t_f$	Fall Time	IRFK6H250	-	105	-	ns	$R_{SOURCE}=3.3\Omega$
		IRFK6J250	-	170	-	ns	
$L_{DS}$	Drain-to-Source Inductance	-	18	-	nH		
$C_{iss}$	Input Capacitance	-	15	-	nF	$V_{GS}=0V, V_{DS}=25V,$	
$C_{oss}$	Output Capacitance	-	4.0	-	nF	$f=1.0MHz$	
$C_{riss}$	Reverse Transfer Capacitance	-	1.5	-	nF		
	Linear Derating Factor	-	-	5	W/K		

## Source-Drain Diode Ratings and Characteristics

Parameter	Parameter	Min.	Typ.	Max.	Units	Test Conditions
$I_S$	Continuous Source Current (Body Diode)	-	-	140	A	
$I_{SM}$	Pulsed Source Current (Body Diode)	-	-	490	A	
$V_{SD}$	Diode Forward Voltage	-	-	2.0	V	$V_{GS}=0V, I_S=140A, T_C=25^\circ\text{C}$
$t_{rr}$	Reverse Recovery Time	140	300	630	ns	$di/dt=400A/\mu s, T_J=150^\circ\text{C}$
$Q_{rr}$	Reverse Recovered Charge	10.0	23.0	50.0	$\mu\text{C}$	$I_S=140A$

### Notes:

④ - Pulse Width  $\leq 300\mu s$ ; Duty cycle  $\leq 2\%$ .



# IRFK6H250, IRFK6J250

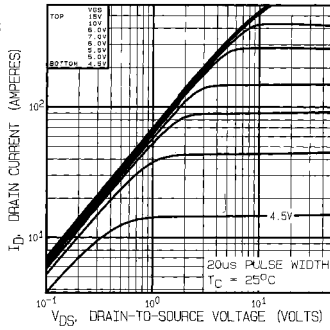


Fig 1. Typical Output Characteristics,  $T_C=25^\circ\text{C}$

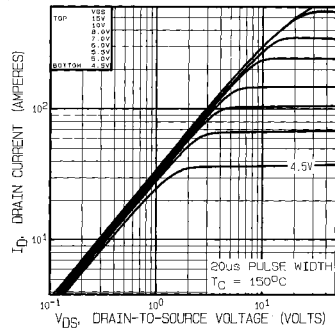


Fig 2. Typical Output Characteristics,  $T_C=150^\circ\text{C}$

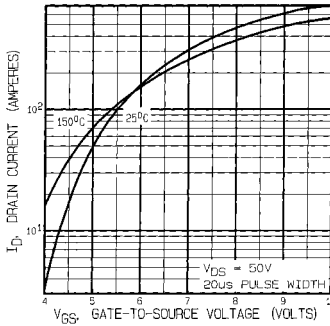


Fig 3. Typical Transfer Characteristics

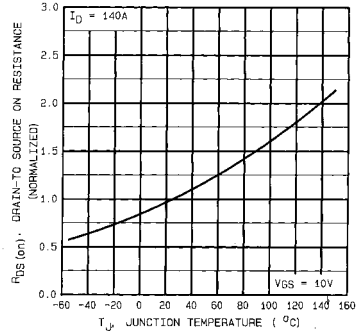
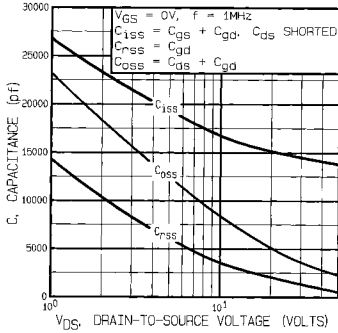
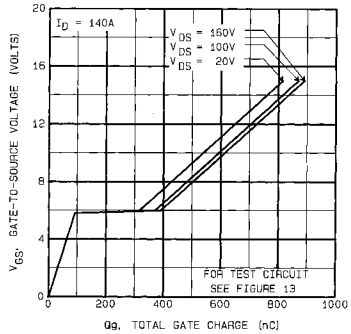


Fig 4. Normalized On-Resistance Vs. Temperature

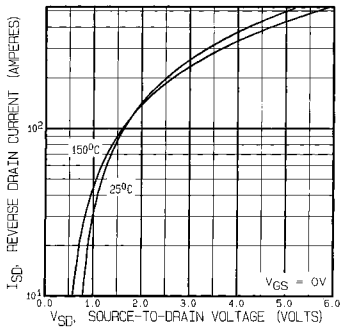
# IRFK6H250, IRFK6J250



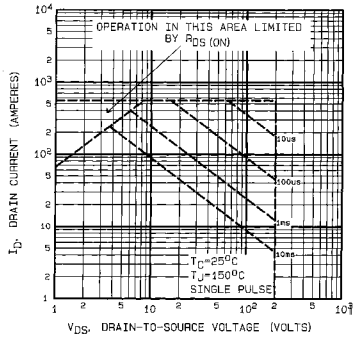
**Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage**



**Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage**



**Fig 7. Typical Source-Drain Diode Forward Voltage**



**Fig 8. Maximum Safe Operating Area**



# IRFK6H250, IRFK6J250

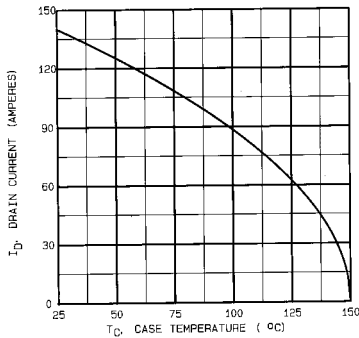


Fig 9. Maximum Drain Current Vs. Case Temperature

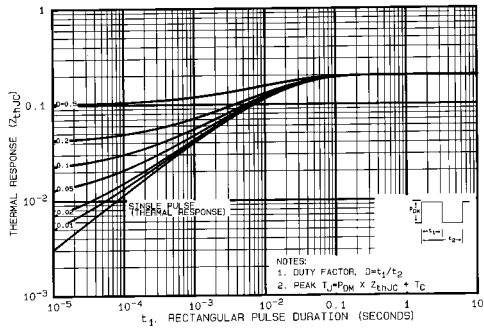


Fig 10. Maximum Effective Transient Thermal Impedance, Junction-to-Case

# IRFK6H250, IRFK6J250

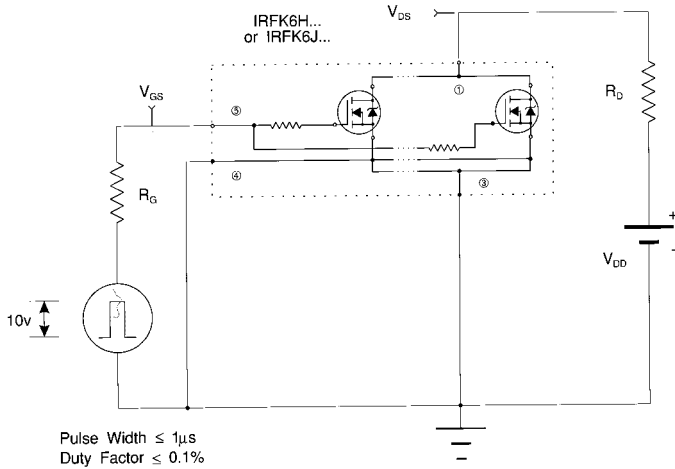


Fig 11a. Switching Time Test Circuit

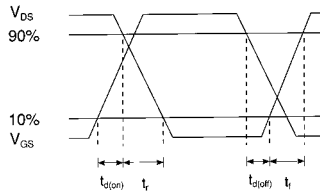
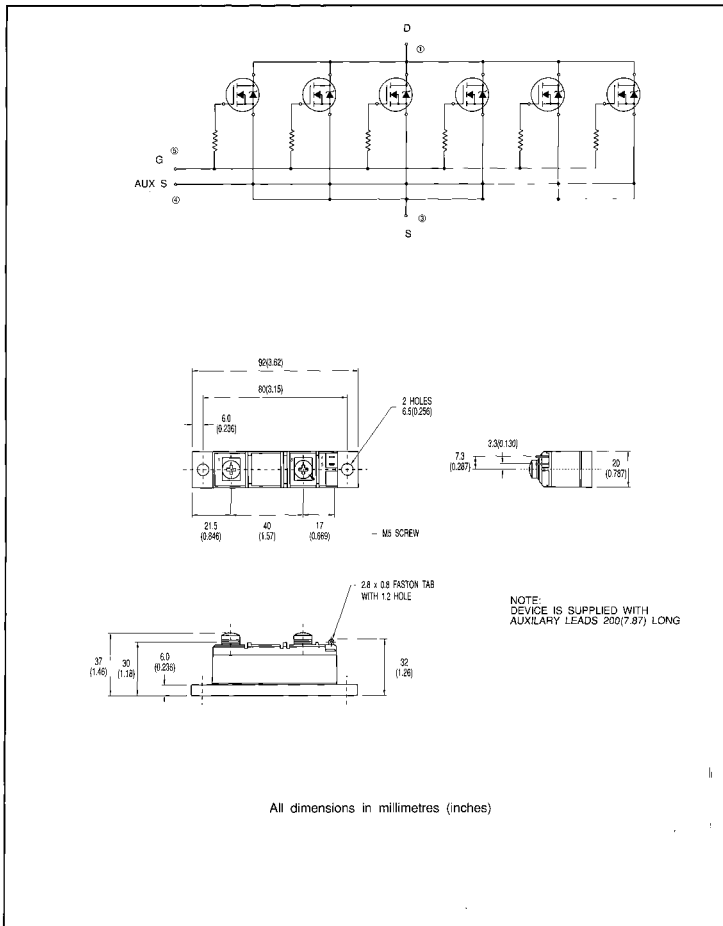


Fig 11b. Switching Time Waveforms

**ICR**

# IRFK6H250, IRFK6J250

## Circuit Configuration and Outline

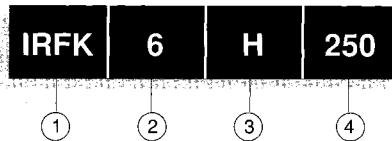


All dimensions in millimetres (inches)

# IRFK6H250,IRFK6J250



## Part Numbering



1. - HEX-pak Module.
2. - Number of HEXFETs in parallel.
3. - H - Fast switching.
  - J - Oscillation resistant for sensitive applications.
4. - Voltage code:-
  - 054 - 60V
  - 150 - 100V
  - 250 - 200V
  - 350 - 400V
  - 450 - 500V
  - C50 - 600V

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